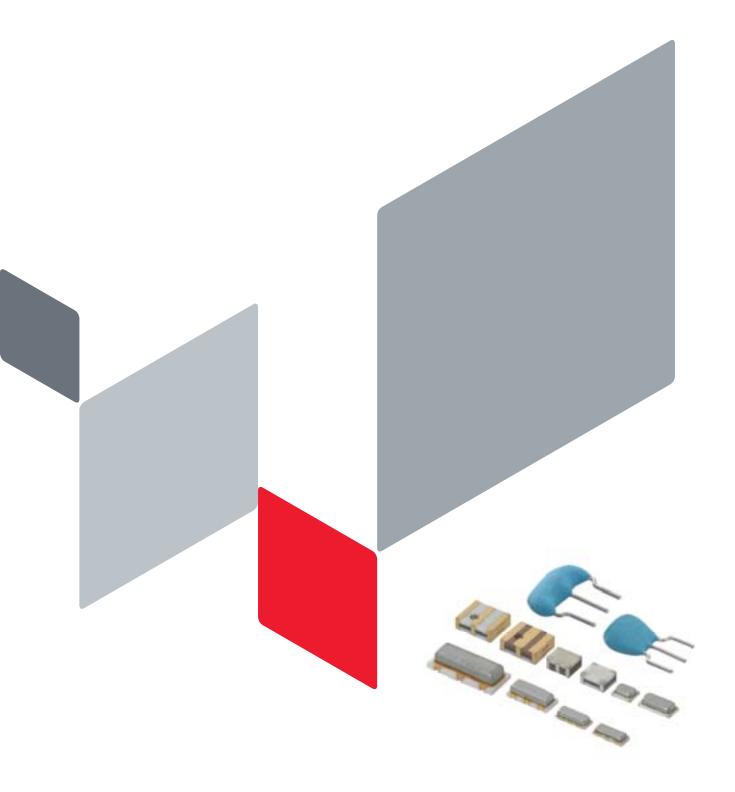


Ceramic Resonators (CERALOCK[®])



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EU RoHS Compliant

- All the products in this catalog comply with EU RoHS.
 EU RoHS is "the European Directive 2011/65/EU on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment."
- For more details, please refer to our website 'Murata's Approach for EU RoHS' (http://www.murata.com/en-eu/support/compliance/rohs).



Contents

in this catalog are the trademarks of

Murata Manufacturing Co., Ltd.

Product specifications are as of March 2015.

CERALOCK®, CERALOCK(R) and "CERALOCK"

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for Consumer/Industrial Usage- p19 Application Circuits Utilization p22 4 MHz Chip Type -Standard Frequency Tolerance for Consumer/Industrial Usage- p23 Application Circuits Utilization p28 5 MHz Lead Type -Standard Frequency Tolerance for Consumer/Industrial Usage- p30 Application Circuits Utilization p32

Please check the MURATA home page (http://www.murata.com/) if you cannot find the part number in the catalog.

Downloaded from Arrow.com.



Application Circuits Utilization p11 Notice for Automotive p12 3 MHz Chip Type - Tight Frequency Tolerance

Selection Guide

Part Numbering ·····

-Tight Frequency Tolerance for Automotive-

Application Circuits Utilization

-Standard Frequency Tolerance for Automotive- ····

1 MHz Chip Type

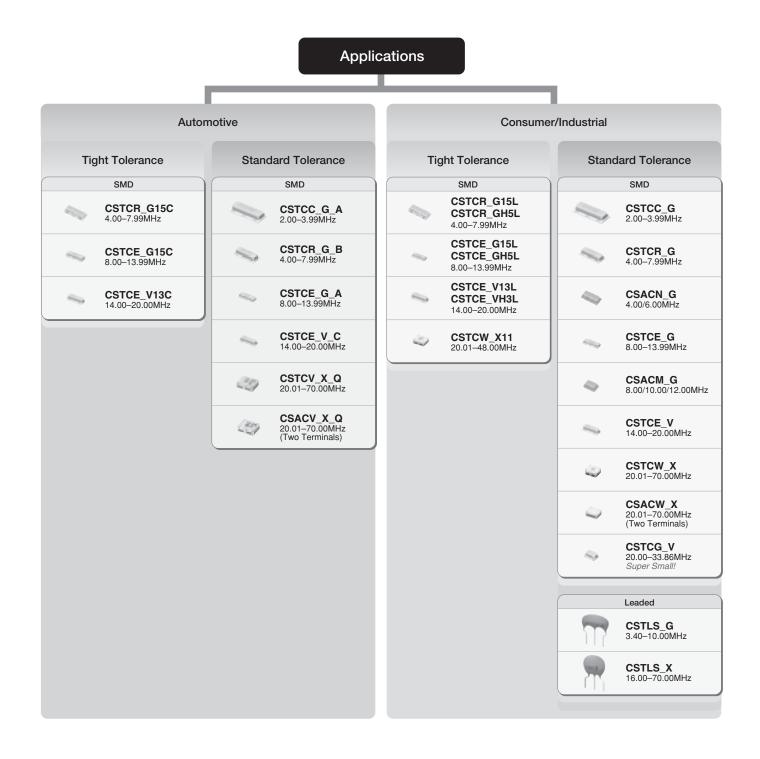
2 MHz Chip Type

Notice for Consumer/Industrial Usage	
MHz Chip Type ·····	p33
MHz Lead Type ·····	p38
Packaging for Consumer/Industrial Usage	
MHz Chip Type ·····	p39
MHz Lead Type ·····	p42

Note
 Please read rating and
 CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
 This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

P16E.pdf Mar.17,2015

Selection Guide



Notice: "CERALOCK[®] for consumer" and "CERALOCK[®] for automotive" is different in the specification of Operating Temperature Range, Environmental Characteristics, Physical Characteristics and so on. Please choose either "for consumer" or "for automotive" according to the required specification.

muRata

Part Numbering

CERALOCK[®] (MHz)

(Part Number)	CS	Т	CE	16M0	V	5	3	***	-R0
	0	2	3	4	6	6	7	8	9

Product ID

Product ID	
CS	Ceramic Resonators

2Frequency/Capacitance

Code	Frequency/Capacitance
Α	MHz with No Capacitance Built-in
т	MHz with Built-in Capacitance

3Structure/Size

Code	Structure/Size
LS	Round Lead Type
CC	Cap Chip Type
CR/CE/CG/CN/CM	Small-cap Chip Type
CV	Monolithic Chip Type
CW	Small Monolithic Chip Type

4Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Decimal point is expressed by capital letter "M."

Design

Code	Design
G	Thickness Shear mode
T/V	Thickness Expander mode
Х	Thickness Expander mode (3rd overtone)

6 Initial Frequency Tolerance

Code	Initial Frequency Tolerance
5	±0.5%
3	±0.3%
2	±0.2%
1	±0.1%
Н	±0.07%

Load Capacity

Code	Load Capacity
1	5/6pF
2	10pF
3	15pF
4	22pF
5	30/33/39pF
6	47pF

Individual Specification

Code	Individual Specification
***	Three-digit alphanumerics express "Individual Specification."

With standard products, "Individual Specification" and "IPackaging" is omitted.

Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H ₀ =18mm
-R0/*R0	Plastic Taping ø=180mm Reel
-R1	Plastic Taping ø=330mm Reel
B # 1 + 1 + 1	

• Radial taping is applied to lead type and plastic taping to chip type.

• In case of CSACN and CSACM series, the hyphen "-" is replaced to a figure which means frequency rank. This figure zero "0" signifies standard part number.

Ceramic Resonators (CERALOCK[®])

MHz Chip Type -Tight Frequency Tolerance for Automotive-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors. This diverse series owes its development to MURATA's original mass production techniques and high reliability. and has achieved importance in the worldwide automotive market.

Features

- 1. The series are high accuracy resonators whose total tolerance is available for less than ±3,000ppm.
- 2. The series has high reliability and is available for a wide temperature range.
- 3. Oscillation circuits do not require external load capacitors.
- 4. The series is available for a wide frequency range.
- 5. The resonators are extremely small and have a low profile.
- 6. No adjustment is necessary for oscillation circuits.

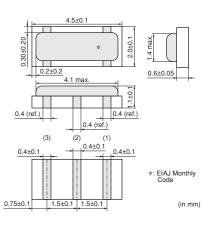
Applications

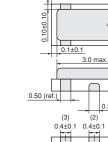
- 1. Cluster panel and Control panel
- 2. Safety control
 - (Anti-lock Brake System, Electronic Stability Control, Airbag, etc.)
- 3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Intelligent Transportation System
- (Lane Keeping System, Millimeter wave radar, etc.)
- 6. Battery control for hybrid cars



CSTCR G15C

4.00-7.99MHz

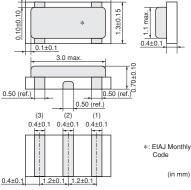




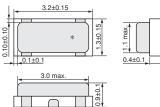
0.5 (ref.)

0.4±0.1

3.2±0.15







0.5 (ref.)

1.2±0.1 1.2±0.1

0.



*: EIAJ Monthly

0.5 (ref.)

(in mm)

Code

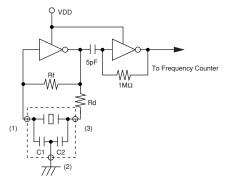
Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15C	4.00 to 7.99	±0.1%	±0.13	-40 to 125
CSTCE_G15C	8.00 to 13.99	±0.1%	±0.13	-40 to 125
CSTCE_V13C	14.00 to 20.00	±0.1%	±0.13	-40 to 125

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

4

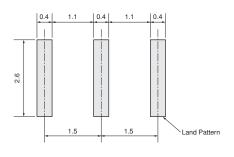
1

Oscillation Frequency Measuring Circuit

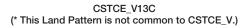


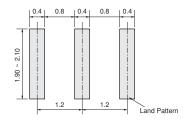
Standard Land Pattern Dimensions CSTCR_G15C

(* This Land Pattern is not common to CSTCR_G.)



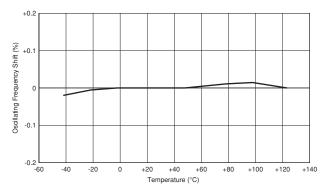
(in mm)



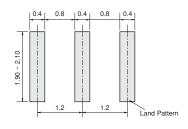


(in mm)



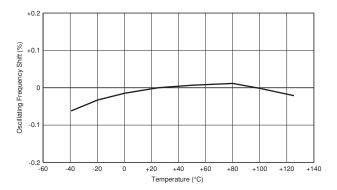


CSTCE_G15C

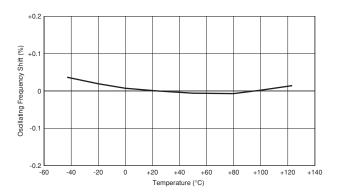


(in mm)

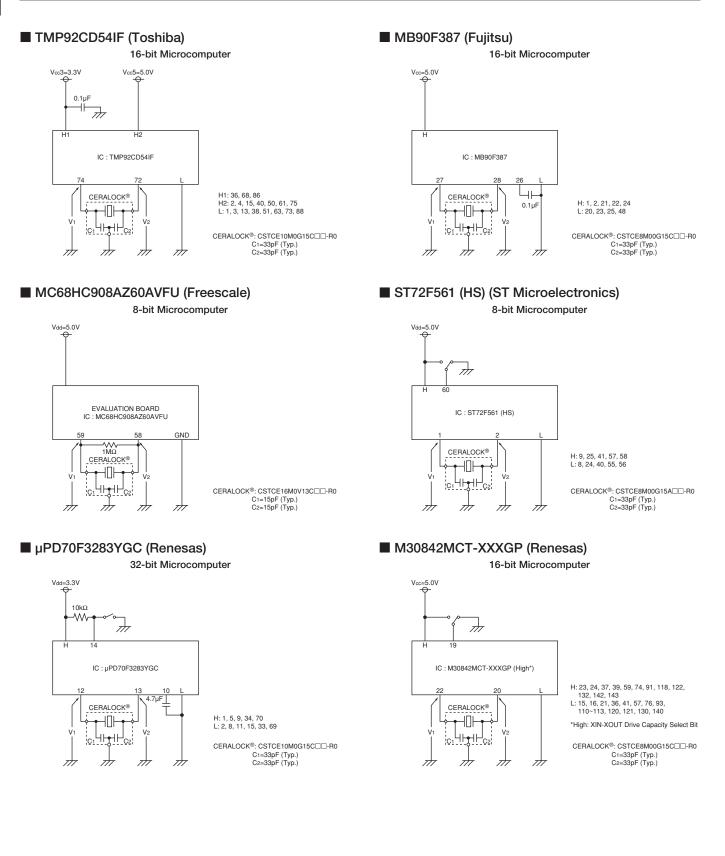
■ Frequency Temperature Characteristics CSTCR_G15C



CSTCE_V13C



Application Circuits Utilization



6

Ceramic Resonators (CERALOCK[®])

MHz Chip Type -Standard Frequency Tolerance for Automotive-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors. This diverse series owes its development to MURATA's original mass production techniques and high reliability. and has achieved importance in the worldwide automotive market.

Features

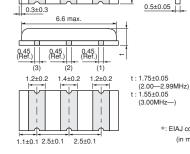
- 1. The series has high reliability and is available for a wide temperature range.
- 2. Oscillation circuits do not require external load capacitors.
- 3. The series is available in a wide frequency range.
- 4. The resonators are extremely small and have a low profile.
- 5. No adjustment is necessary for oscillation circuits.

Applications

- 1. Cluster panel and Control panel
- 2. Safety control (Anti-lock Brake System, Electronic Stability Control, Airbag, etc.)
- 3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Electronic Toll Collection system, Car Navigation, etc.



CSTCC G A 2.00-3.99MHz



4.5±0.1

7.2±0.2 $\neg \neg$

(M

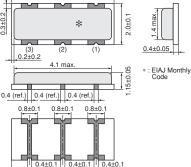
3.0±0.2 nax

0.45±0.3

0.3±0.2

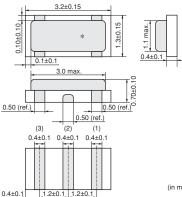


(in mm)

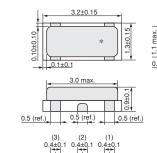


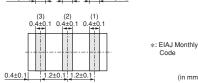
0.75±0.1 1.5±0.1

1.5±0.1



(in mm)





Continued on the following page.



CSTCE G A 8.00-13.99MHz

CSTCE_V_C

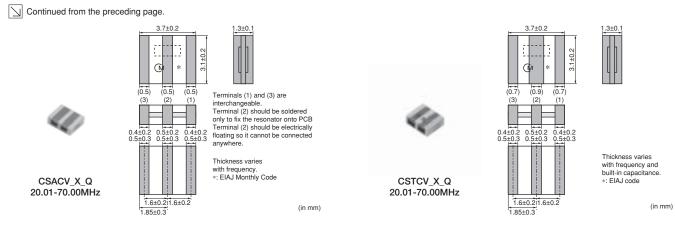
14.00-20.00MHz



(in mm)

ANote • Please read rating and
 CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
 • This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.
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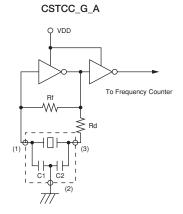
P16E.pdf Mar.17,2015



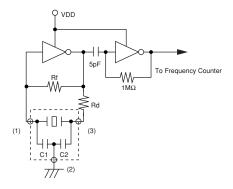
Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G_A	2.00 to 3.99	±0.5%	± 0.4 [-0.6% to +0.3%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-40 to 125
CSTCR_G_B	4.00 to 7.99	±0.5%	±0.15	-40 to 125
CSTCE_G_A	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSTCE_V_C	14.00 to 20.00	±0.5%	±0.15	-40 to 125
CSACV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125
CSTCV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

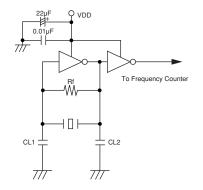
Oscillation Frequency Measuring Circuit



CSTCE_G_A/CSTCE_V_C/CSTCR_G_B/CSTCV_X_Q



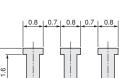
CSACV_X_Q



8

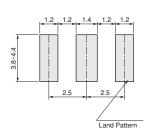
ANote • Please read rating and ACAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

Standard Land Pattern Dimensions



2.6

CSTCR_G_B



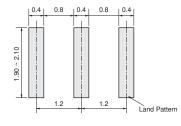
CSTCE_G_A

(in mm)

0.4 0.4 0.4 1.5 1.5 Land Pattern

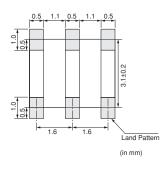
(in mm)

CSTCE_V_C (* This Land Pattern is not common to CSTCE_V.)

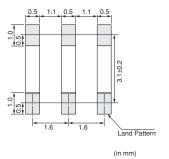


(in mm)

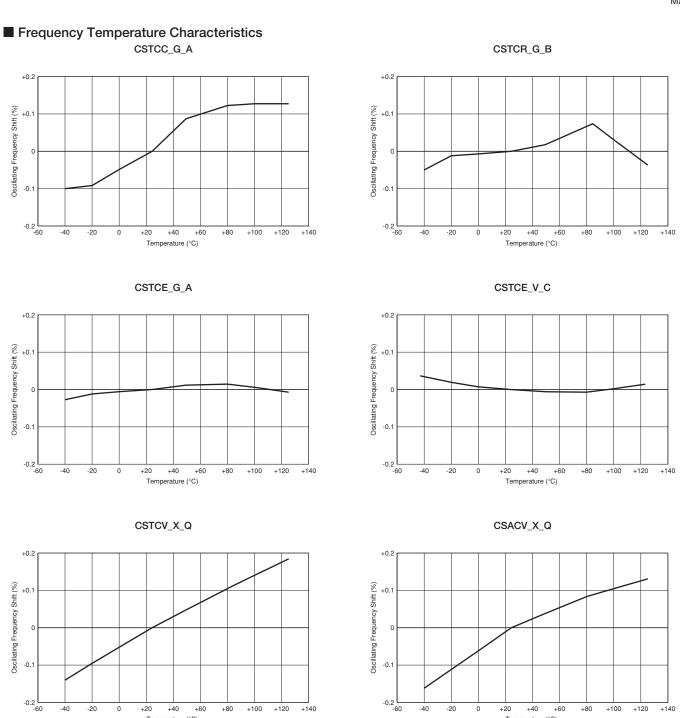




CSACV_X_Q



(in mm)



10

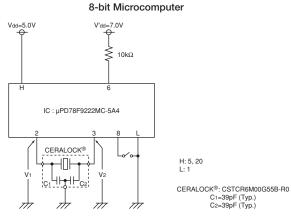
Temperature (°C)

muRata

Temperature (°C)

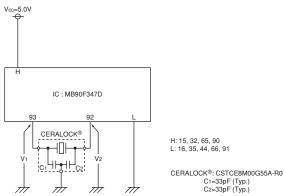
Application Circuits Utilization

■ µPD78F9222MC-5A4 (Renesas)

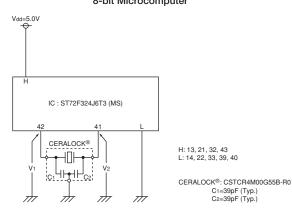


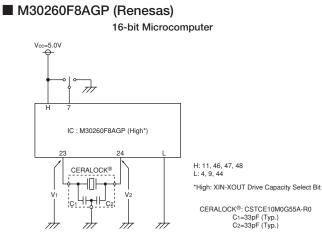
MB90F347D (Fujitsu)

16-bit Microcomputer



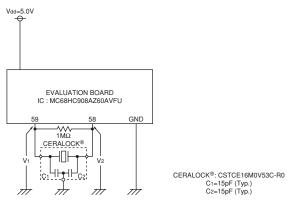
ST72F324J6T3 (MS) (ST Microelectronics) 8-bit Microcomputer





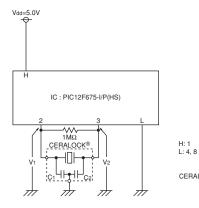
MC68HC908AZ60AVFU (Freescale)

8-bit Microcomputer



PIC12F675-I/P (HS) (Microchip)

8-bit Microcomputer



CERALOCK[®]: CSTCE8M00G52A-R0 C1=10pF (Typ.) C2=10pF (Typ.)

■ Soldering and Mounting (CSTCC/CSTCR/CSTCE_V/CSTCE_G Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Pasammandable Elux and Salder

Recommendable	Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
De als Tarran anatarra	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

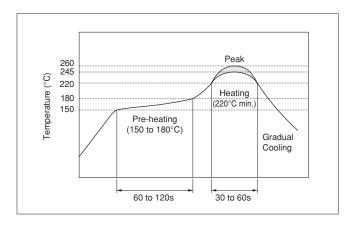
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



Continued on the following page. $\boxed{\circlel{A}}$

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Continued from the preceding page.

2. Wash

- Cleaning Solvents HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW
- (2) Temperature Difference : dT *1
 - $dT \leq 60^{\circ}C$ (dT=Component-solvent)
 - *1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.
- (3) Conditions
 - (a) Ultrasonic Wash
 - 1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/l)
- (4) Drying

5 minutes max. by air blow at +80°C max.

- (5) Other
 - (a) Total washing time should be within 10 minutes.
 - (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.
- 3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained. (b) Immersion Wash

5 minutes max. in above solvent at +60°C max.

(c) Shower or Rinse Wash5 minutes max. in above solvent at +60°C max.

Soldering and Mounting (CSTCV/CSACV Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other

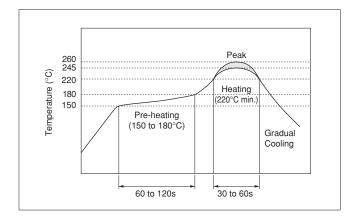
Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

2. Wash

- (1) Cleaning Solvents
 - HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW
- (2) Temperature Difference : dT *1
 - dT≦60°C (dT=Component-solvent)
 - *1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.



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- Continued from the preceding page.
- (3) Conditions
 - (a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/l)

(4) Drying

5 minutes max. by air blow at +80°C max.

- (5) Other
 - (a) Total washing time should be within 10 minutes.
 - (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.
- 3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained. (b) Immersion Wash

5 minutes max. in above solvent at +60°C max. (c) Shower or Rinse Wash

5 minutes max. in above solvent at +60°C max.

Storage and Operating Conditions

1. Product Storage Conditions

Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

2. Expiration Date on Storage

Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty.

Please confirm solderability and characteristics for the products regularly.

3. Notice on Product Storage

 Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm that stable electrical characteristics are maintained.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

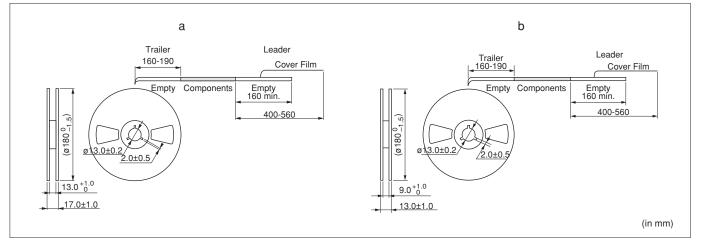
16

Packaging for Automotive

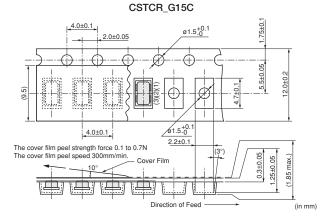
Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G_A	2,000	6,000	500	а
CSTCR_G_B	3,000	9,000	500	а
CSTCR_G15C	3,000	9,000	500	а
CSTCE_G_A	3,000	9,000	500	b
CSTCE_G15C	3,000	9,000	500	b
CSTCE_V_C	3,000	9,000	500	b
CSTCE_V13C	3,000	9,000	500	b
CSTCV_X_Q	2,000	6,000	500	а
CSACV X Q	2.000	6,000	500	а

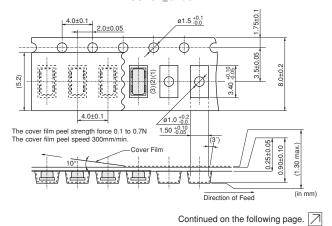
Dimensions of Reel



Dimensions of Taping



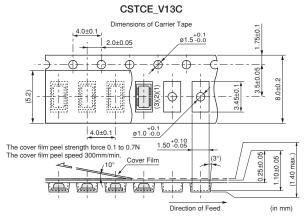
CSTCE_G15C



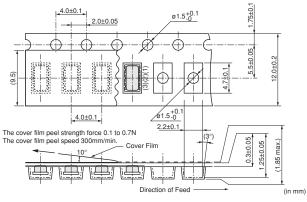
Packaging for Automotive

Continued from the preceding page.

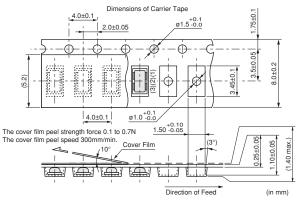
Dimensions of Taping



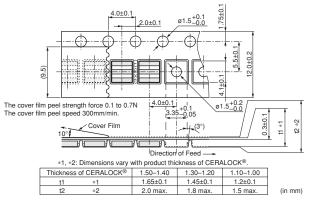


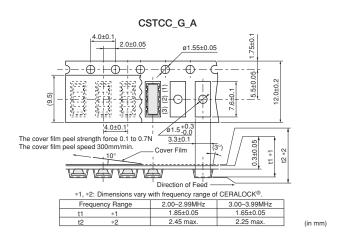




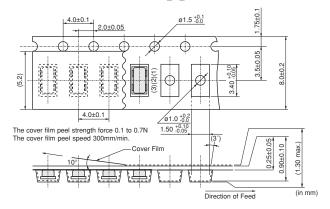




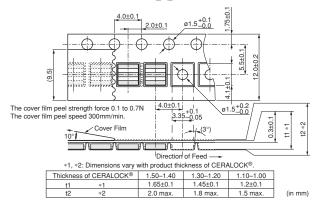




CSTCE_G_A



CSTCV_X_Q



Ceramic Resonators (CERALOCK[®])

MHz Chip Type -Tight Frequency Tolerance for Consumer/Industrial Usage-

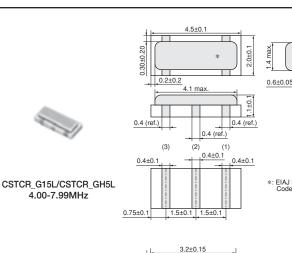
Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and packaging technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors. High-density mounting is made possible by the small package and the elimination of the need for an external load capacitor.

Features

- 1. Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

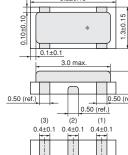
Applications

- 1. Clock oscillators for USB (Full-speed) controller ICs
- 2. Audio equipment and musical instruments, etc.
- 3. Other applications for replacement of Crystal units/ Oscillators

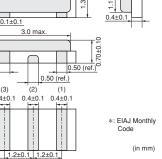




(in mm)

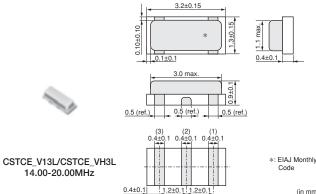


0.4±0.1



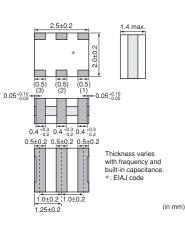
max.

CSTCE_G15L/CSTCE_GH5L 8.00-13.99MHz



(in mm)

CSTCW X11 20.01-48.00MHz



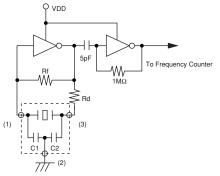
Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15L	4.00 to 7.99	±0.1%	±0.08	0 to 70
CSTCR_GH5L	4.00 to 7.99	±0.07%	±0.08	0 to 70
CSTCE_G15L	8.00 to 13.99	±0.1%	±0.08	0 to 70
CSTCE_GH5L	8.00 to 13.99	±0.07%	±0.08	0 to 70
CSTCE_V13L	14.00 to 20.00	±0.1%	±0.08	0 to 70
CSTCE_VH3L	14.00 to 20.00	±0.07%	±0.08	0 to 70
CSTCW_X11	20.01 to 48.00	±0.1%	±0.1	0 to 70

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

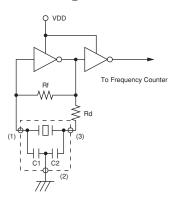
3

Oscillation Frequency Measuring Circuit

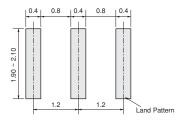
CSTCR_G15L/CSTCR_GH5L/CSTCE_G15L/ CSTCE_GH5L/CSTCE_V13L/CSTCE_VH3L





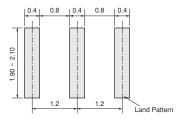


CSTCE_G15L/CSTCE_GH5L



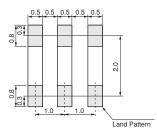
(in mm)

CSTCE_V13L/CSTCE_VH3L (* This Land Pattern is not common to CSTCE_V.)



(in mm)

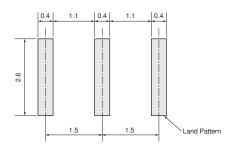
CSTCW_X11



(in mm)

(in mm)

Standard Land Pattern Dimensions CSTCR_G15L/CSTCR_GH5L (* This Land Pattern is not common to CSTCR_G.)



+0.2

+0.1

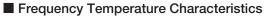
С

-0.1

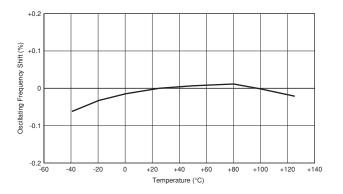
-0.2 L -60

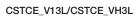
-40 -20

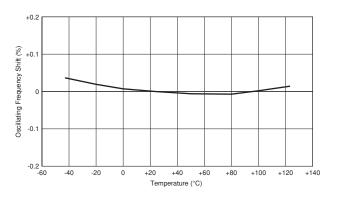
Oscillating Frequency Shift (%)



CSTCR_G15L/CSTCR_GH5L







CSTCW_X11

+40

Temperature (°C)

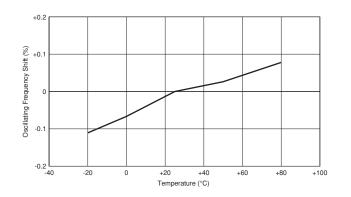
+60

+80 +100

+20

0

CSTCE_G15L/CSTCE_GH5L



3

+120

+140

CERALOCK[®]: CSTCR6M00G15□□-R0 C1=39pF (Typ.) C2=39pF (Typ.)

H: 8, 19, 39 L: 5, 20, 40 H1: 31, 33 L1: 29, 30, 32, 34~36

CERALOCK[®]: CSTCE12M0G15L□□-R0 C1=33pF (Typ.) C2=33pF (Typ.)

Application Circuits Utilization

M66291GP (Renesas)

EVALUATION BOARD IC : M66291GP

₹220Ω

की की

1MΩ CERALOCK®

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 $\overline{\mathcal{H}}$

LC87F1964A (Sanyo)

 $\leq 10k\Omega$

IC : LC87F1964A

C2

 π

Vset=3.3V

 $\overline{}$

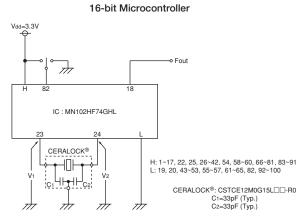
Vdd=5.0V

USB Transceiver

GND

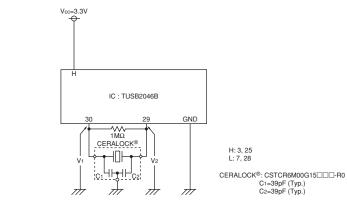
8-bit Microcontroller

MN102HF74GHL (Panasonic)



TUSB2046B (Texas Instruments)

USB 4-port HUB



ISP1181BDGG (Philips)

비

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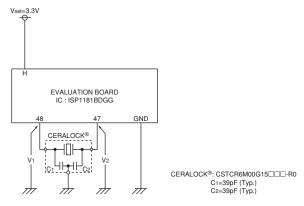
 $\overline{}$

<u>C1</u>

 π

USB Controller

 \overline{H}



22

Ceramic Resonators (CERALOCK[®])

MHz Chip Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

Chip type CERALOCK(R) with built-in load capacitors provides an extremely small package.

MURATA's package technology expertise has enabled the development of the Chip CERALOCK(R) with built-in load capacitors.

High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

Features

- 1. Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

Applications

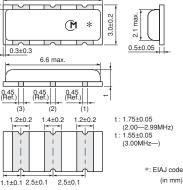
- 1. Clock oscillators for microprocessors
- 2. Small electronic equipment such as handheld phone, digital video camcorder (DVC), digital still camera (DSC), portable audio player, etc.
- 3. Storage media and memory (HDD, Optical storage device, FDD, Flash memory card, etc.)
- 4. Office automation equipment (Mobile PC, Mouse, Keyboard, etc.)
- 5. Audio-visual applications (TV, DVD-HDD recorder, Audio equipment, Remote control, etc.)

6. Home appliances

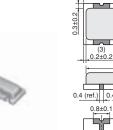
(Air conditioner, Microwave oven, Refrigerator, Washing machine, etc.)

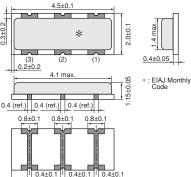


CSTCC G 2.00-3.99MHz



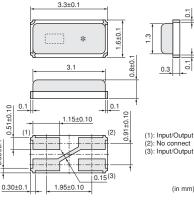
7.2±0.2





0.75±0.1 1.5±0.1

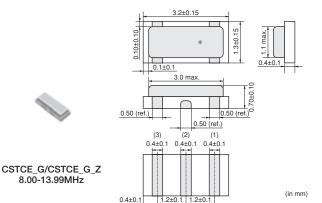




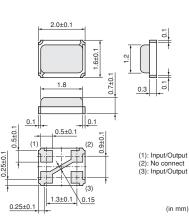
1.5±0.1

CSACN G 4.00/6.00MHz

0.30±0.1



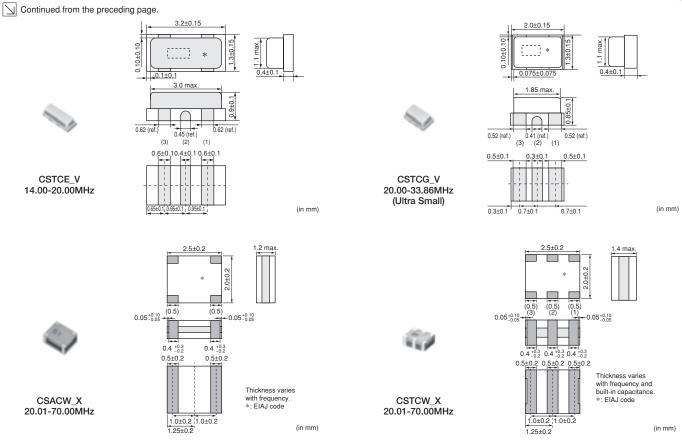




Continued on the following page.

CSTCR G 4.00-7.99MHz

Note
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 CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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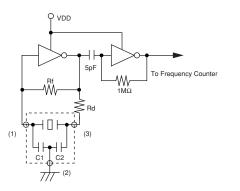
Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G	2.00 to 3.99	±0.5%	±0.3 [±0.4%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-20 to 80
CSTCR_G	4.00 to 7.99	±0.5%	±0.2	-20 to 80
CSACN_G*	4.00, 6.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_G	8.00 to 13.99	±0.5%	±0.2	-20 to 80
CSTCE_G_Z	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSACM_G*	8.00, 10.00, 12.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_V	14.00 to 20.00	±0.5%	±0.3	-20 to 80
CSTCG_V	20.00 to 33.86	±0.5%	±0.3	-20 to 80
CSACW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80
CSTCW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

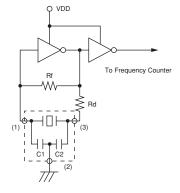
*: Please refer to Notice.

Oscillation Frequency Measuring Circuit

CSTCR_G/CSTCE_G/CSTCE_G_Z/CSTCE_V/CSTCG_V



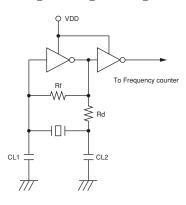
CSTCC_G/CSTCW_X



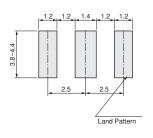
Continued on the following page.

24

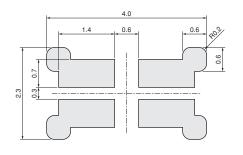
CSACN_G/CSACM_G/CSACW_X



Standard Land Pattern Dimensions CSTCC_G

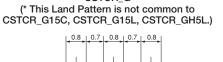




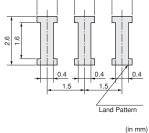


(in mm)

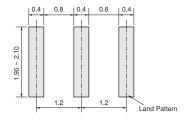
(in mm)



CSTCR_G

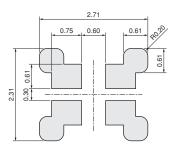


CSTCE_G/CSTCE_G_Z



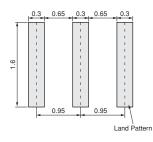
(in mm)

CSACM_G



(in mm)

CSTCE_V (* This Land Pattern is not common to CSTCE_V13C, CSTCE_V_C, CSTCE_V13L, CSTCE_VH3L.)



(in mm)

Continued on the following page.

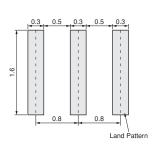


ANote • Please read rating and ACAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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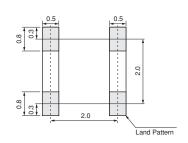
Continued from the preceding page.







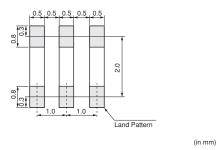
(in mm)



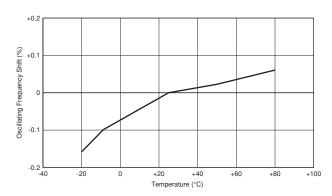
CSACW_X

(in mm)

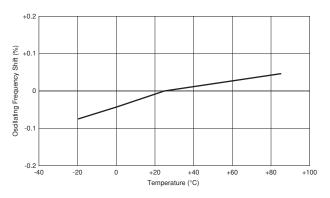
CSTCW_X



■ Frequency Temperature Characteristics CSTCC_G







CSTCE_G/CSTCE_G_Z

+40

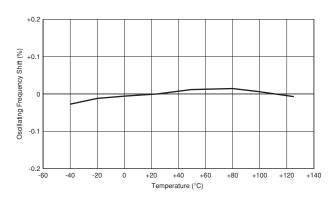
Temperature (°C)

+60

+80

+20

CSTCR_G



Continued on the following page.

+100 +120 +140

+0.2

+0.1

0

-0.1

-0.2 -60

-40

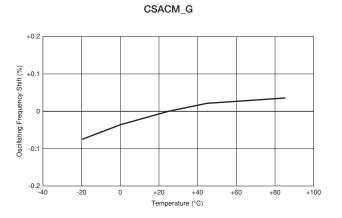
-20

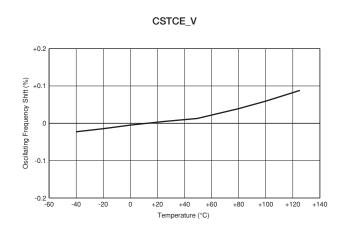
0

Oscillating Frequency Shift (%)

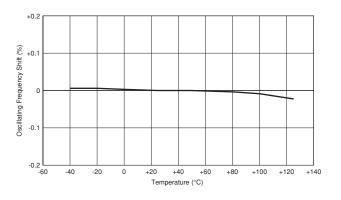
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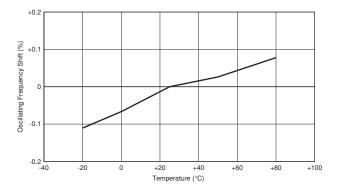




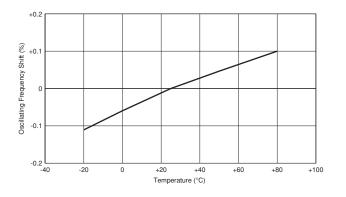








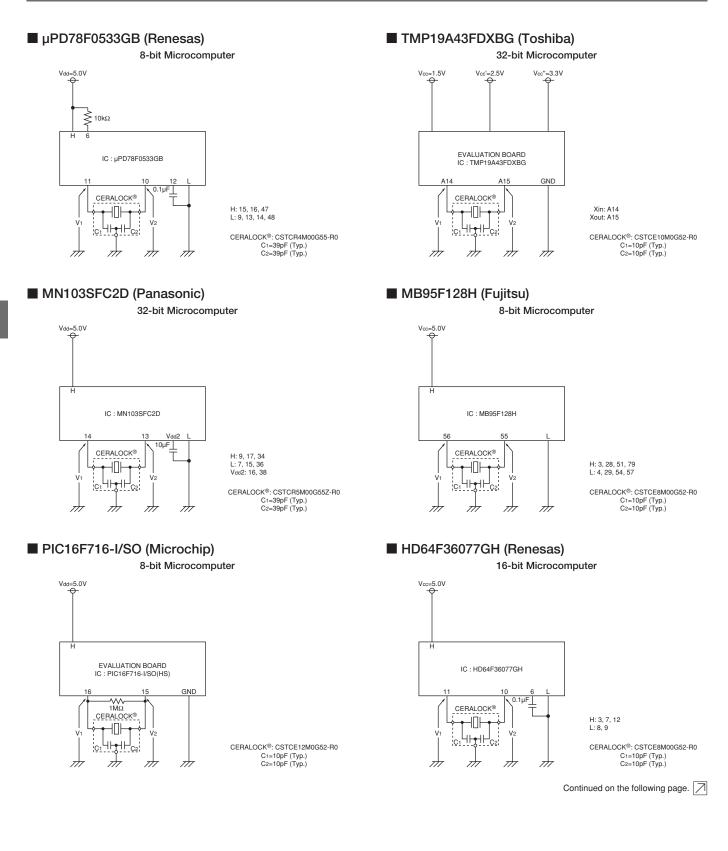






P16E.pdf Mar.17,2015

Application Circuits Utilization



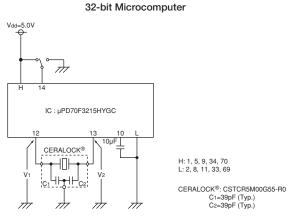
28

Note
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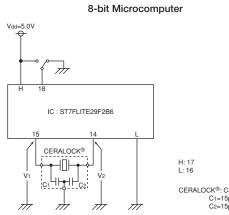
Application Circuits Utilization

Continued from the preceding page.

■ µPD70F3215HYGC (Renesas)

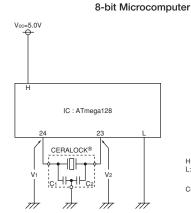


ST7FLITE29F2B6 (ST Microelectronics)



H: 17 L: 16
CERALOCK [®] : CSTCE16M0V53-R0 C1=15pF (Typ.) C2=15pF (Typ.)

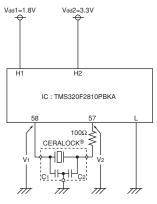
ATmega128 (Atmel)



H: 21, 52, 64 L: 22, 53, 63 CERALOCK[®]: CSTCE8M00G52-R0 C1=10pF (Typ.) C2=10pF (Typ.)

TMS320F2810PBKA (Texas Instruments)

32-bit Microcomputer



H1: 20, 29, 42, 56, 63, 74, 82, 94, 99, 100, 102, 110, 114 H2: 1, 13, 14, 25, 49, 52, 83, 104, 118 L: 12, 15, 17, 26, 30, 39, 53, 59, 62, 73, 88, 95, 103, 109, 115, 117, 128

CERALOCK[®]: CSTCE15M0V53-R0 C1=15pF (Typ.) C2=15pF (Typ.) 4

Ceramic Resonators (CERALOCK[®])

MHz Lead Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

MURATA's ceramic resonator, CERALOCK(R) with built-in load capacitors, has been widely applied as the most suitable component for clock oscillators in a broad range of microprocessors.

The CSTLS series can be used in the design of oscillation circuits not requiring external load capacitors, enabling both high-density mounting and cost reduction.

Features

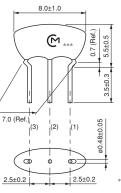
- 1. Oscillation circuits do not require external load capacitors.
 - There is some variation in built-in capacitance values applicable to various IC.
- 2. Stable over a wide temperature range.
- 3. Compact, lightweight and exhibit superior shock resistance performance.
- 4. Enable the design of oscillator circuits requiring no adjustment.
- 5. Cost-effective and reliable availability

Applications

5

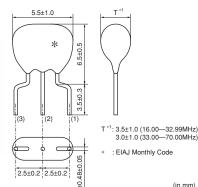
- 1. DTMF generators
- 2. Clock oscillators for microcomputers
- 3. Remote control units
- 4. Automated office equipment







3.0±1.0



(in mm)

16.00-70.00MHz

CSTLS X

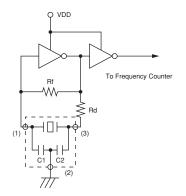
Operating Temperature Range Initial Frequency Frequency Shift by Temperature Part Number (MHz) Tolerance (%) (°C) ±0.5% CSTLS_G 3.40 to 10.00 ±0.2 [-0.4% to +0.2%:Built-in Capacitance 47pF type] -20 to 80 CSTLS X 16.00 to 70.00 ±0.5% -20 to 80 +0.2

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

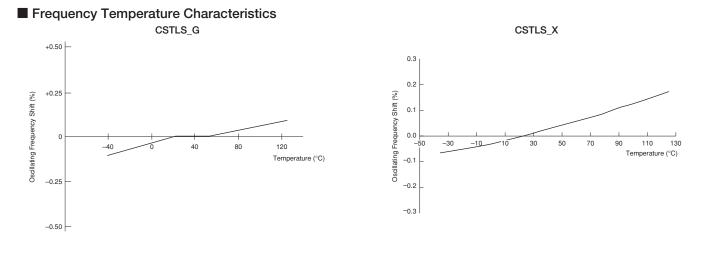
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

Oscillation Frequency Measuring Circuit

CSTLS G/CSTLS X



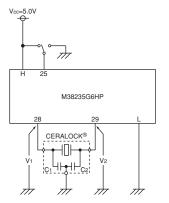
30



Application Circuits Utilization

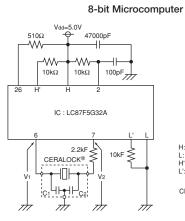
M38235G6HP (Renesas)

8-bit Microcomputer



H: 71 L: 30, 73

CERALOCK®: CSTLS8M00G53-B0 C1=15pF (Typ.) C2=15pF (Typ.) LC87F5G32A (Sanyo)



H: 8, 19, 39 L: 5, 20, 40 H': 29, 31, 35 L': 30, 32~34, 36

CERALOCK[®]: CSTLS5M00G53-B0 C1=15pF (Typ.) C2=15pF (Typ.)

32

Soldering and Mounting (CSTCC Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
De als Tarren arrature	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

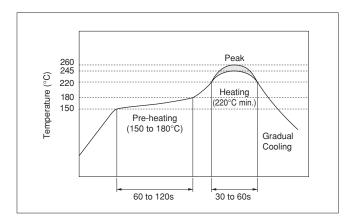
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



Continued on the following page. $\boxed{\circlel{A}}$

Continued from the preceding page.

2. Wash

Some series do not withstand washing. Please check the list at right before use.

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1

dT≦60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

(3) Conditions

(a) Ultrasonic Wash
 1 minute max. in above solvent at +60°C max.
 (Frequency: 28kHz, Output: 20W/l)

(4) Drying

5 minutes max. by air blowing at +80°C max.

(5) Other

- (a) Total washing time should be within 10 minutes.
- (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

Series	Wash
CSTCC (2.00 to 3.49MHz)	Not Available
CSTCC (3.50 to 3.99MHz)	Available

- (b) Immersion Wash
- 5 minutes max. in above solvent at +60°C max.
- (c) Shower or Rinse Wash
 - 5 minutes max. in above solvent at +60°C max.

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Soldering and Mounting (CSTCR/CSTCE_V/CSTCG/CSACN/CSACM/CSTCE_G Series) 1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.	
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.	

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
De els Terren erreterre	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

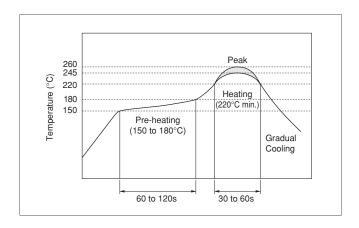
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.

3. CSACN/CSACM Series Oscillation Frequency CSACN/CSACM series is a chip resonator with 2 terminals which does not have built-in load capacitors. Oscillation frequency may vary according to external load capacitance value. Its measurement circuit for standard part number is as shown in Fig.1. Please make sure if oscillation frequency is certainly within a range of frequency tolerance that brings to essential set level performance, when using other value of constant in Fig.1

performance, when using other value of constant in Fig.1. Please contact us if oscillation frequency needs to be adjusted by a chip resonator itself. There would be some ranked part number that we could propose.

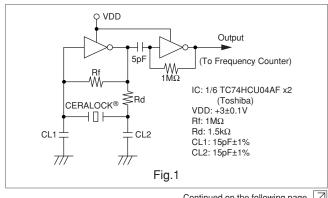


(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.





Continued from the preceding page.

Soldering and Mounting (CSACW/CSTCW Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.	
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.	

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
De als Tarran anatarra	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other

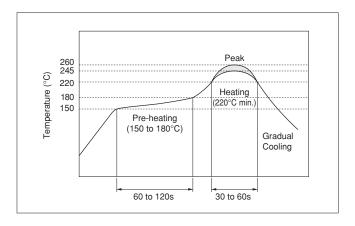
Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.



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Storage and Operating Conditions

1. Product Storage Conditions

Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C

Humidity: 15 to 85% R.H.

2. Expiration Date on Storage

Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.

- 3. Notice on Product Storage
- Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.

Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed. Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

Soldering and Mounting

The component cannot withstand washing. Please do not apply excessive mechanical stress to the component and lead terminals during soldering.

Storage and Operating Conditions

 Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

2. Expiration Date on Storage

Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.

- 3. Notice on Product Storage
- Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.

Rating

The component may be damaged if excessive mechanical stress is applied.

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- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed. Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.

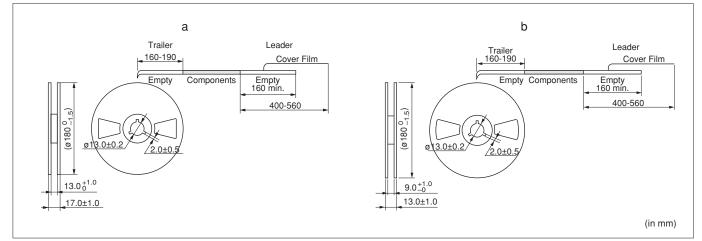
38

Packaging for Consumer/Industrial Usage -MHz Chip Type-

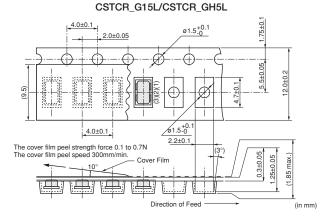
Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G	2,000	6,000	500	а
CSTCR_G	3,000	9,000	500	а
CSTCR_G15L	3,000	9,000	500	а
CSTCR_GH5L	3,000	9,000	500	а
CSACN_G	3,000	-	-	b
CSTCE_G	3,000	9,000	500	b
CSTCE_G15L	3,000	9,000	500	b
CSTCE_GH5L	3,000	9,000	500	b
CSACM_G	3,000	-	-	b
CSTCE_V	3,000	9,000	500	b
CSTCE_V13L	3,000	9,000	500	b
CSTCE_VH3L	3,000	9,000	500	b
CSTCG_V	3,000	9,000	500	b
CSTCW_X	STCW_X 3,000 9,000	9,000	500	b
CSTCW_X11	3,000	9,000	500	b
CSACW_X	3,000	9,000	500	b

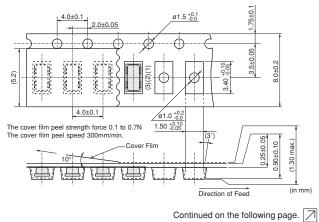
Dimensions of Reel



Dimensions of Taping



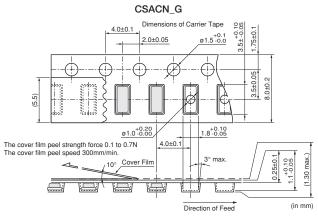
CSTCE_G15L/CSTCE_GH5L



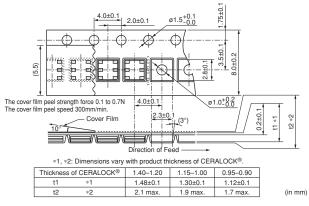
Packaging for Consumer/Industrial Usage -MHz Chip Type-

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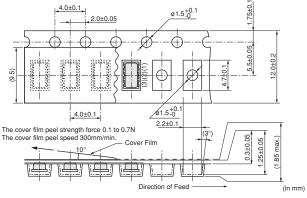
Dimensions of Taping

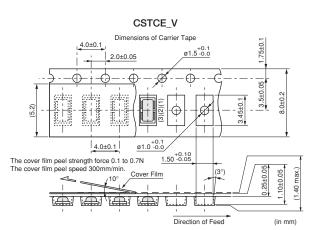


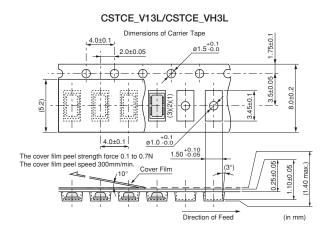


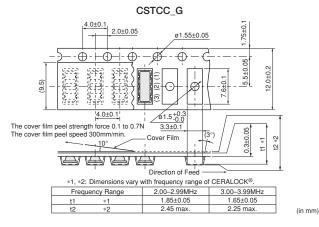




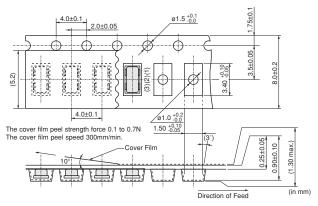




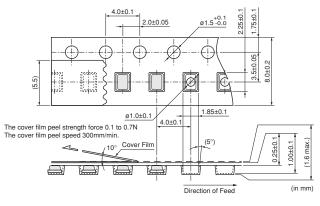








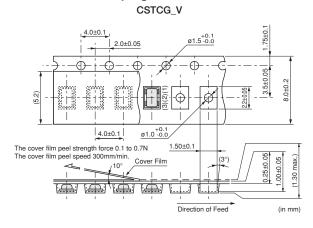




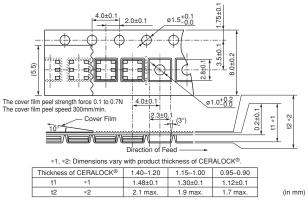
Packaging for Consumer/Industrial Usage -MHz Chip Type-

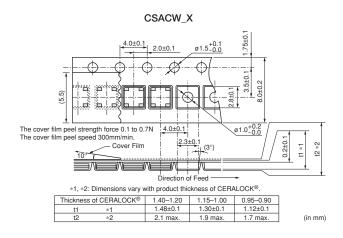
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Dimensions of Taping









(pcs.)

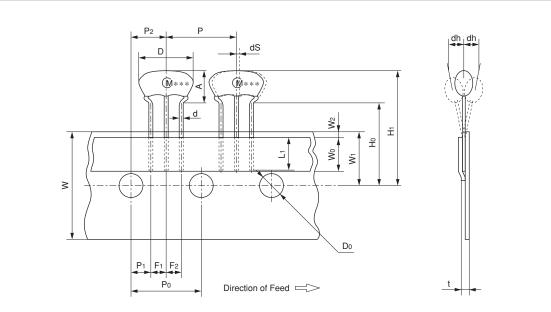
Packaging for Consumer/Industrial Usage -MHz Lead Type-

Minimum Quantity

Part Number	Ammo Pack	Bulk
CSTLS_G (3.40 to 10.0MHz)	2,000	500
CSTLS_X (16.00 to 70.00MHz)	2,000	500

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

Tape Dimensions of CSTLS_G



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	8.0	±1.0	
Height of resonator	A	5.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	_	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xPo=127±1
Pitch of sprocket hole	Po	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P2	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	Wo	6.0 min.	_	Hold down tape does not exceed the carrier tape
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	23.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

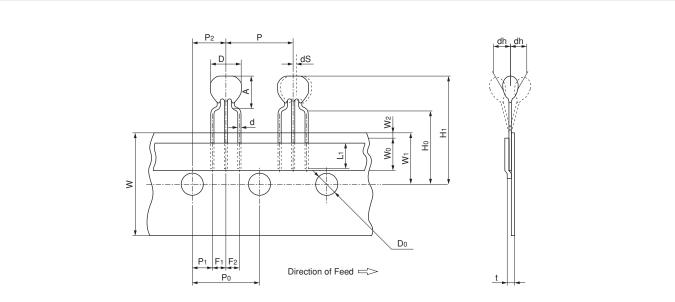
Continued on the following page.

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Packaging for Consumer/Industrial Usage -MHz Lead Type-

Continued from the preceding page.

Tape Dimensions of CSTLS_X



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	A	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	_	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xPo=127±1
Pitch of sprocket hole	P0	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P2	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	Wo	6.0 min.	_	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0.0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	24.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

Global Locations

For details please visit www.murata.com



1 Export Control

For customers outside Japan:

No Murata products should be used or sold, through any channels, for use in the design, development, production, utilization, maintenance or operation of, or otherwise contribution to (1) any weapons (Weapons of Mass Destruction [nuclear, chemical or biological weapons or missiles] or conventional weapons) or (2) goods or systems specially designed or intended for military end-use or utilization by military end-users.

For customers in Japan:

For products which are controlled items subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required for export. Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.

- (1) Aircraft equipment
- Aerospace equipment
- (3) Undersea equipment
- (4) Power plant equipment
- (5) Medical equipment
- Transportation equipment (vehicles, trains, ships, etc.)
- Traffic signal equipment
- B Disaster prevention / crime prevention equipment
- Data-processing equipment
- Application of similar complexity and/or reliability requirements to the applications listed above

Product specifications in this catalog are as of March 2015. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.

Please read rating and ACAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.

This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

- Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
- 7 No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.

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